

**MSAFX11P50A**

**500 Volts**  
**11 Amps**  
**750 mΩ**

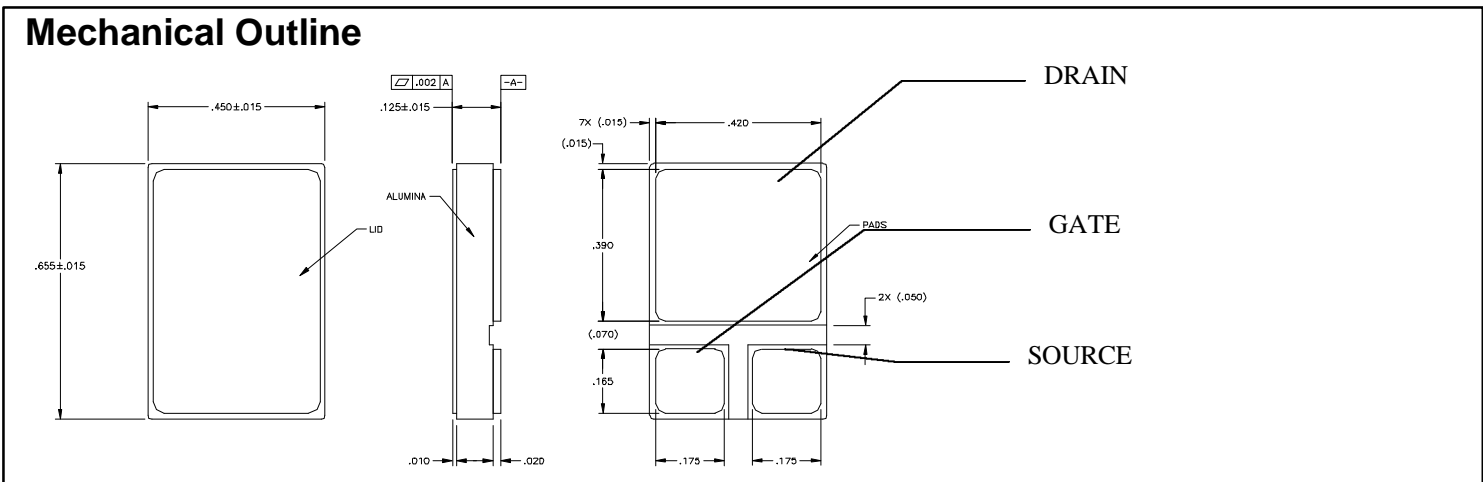
**P-CHANNEL**  
**ENHANCEMENT MODE**  
**POWER MOSFET**

**Features**

- High voltage p-channel power mosfet; complements MSAFX24N50A
- Ultrafast body diode
- Rugged polysilicon gate cell structure
- Increased Unclamped Inductive Switching (UIS) capability
- Hermetically sealed, surface mount power package
- Low package inductance
- Very low thermal resistance
- Reverse polarity available upon request

**Maximum Ratings @ 25°C (unless otherwise specified)**

DESCRIPTION	SYMBOL	MAX.	UNIT
Drain-to-Source Breakdown Voltage (Gate Shorted to Source) @ T <sub>J</sub> ≥ 25°C	BV <sub>DSS</sub>	500	Volts
Drain-to-Gate Breakdown Voltage @ T <sub>J</sub> ≥ 25°C, R <sub>GS</sub> = 1 MΩ	BV <sub>DGR</sub>	500	Volts
Continuous Gate-to-Source Voltage	V <sub>GS</sub>	+/-20	Volts
Transient Gate-to-Source Voltage	V <sub>GSM</sub>	+/-30	Volts
Continuous Drain Current 100°C	I <sub>D25</sub> I <sub>D100</sub>	11 8	Amps
Peak Drain Current, pulse width limited by T <sub>Jmax</sub>	I <sub>DM</sub>	44	Amps
Repetitive Avalanche Current	I <sub>AR</sub>	11	Amps
Repetitive Avalanche Energy	E <sub>AR</sub>	30	mJ
Single Pulse Avalanche Energy	E <sub>AS</sub>	tbd	mJ
Voltage Rate of Change of the Recovery Diode @ I <sub>S</sub> ≤ I <sub>DM</sub> , di/dt ≤ 100 A/μs, V <sub>DD</sub> ≤ V <sub>DSS</sub> , T <sub>J</sub> ≤ 150°C	dv/dt	5.0	V/ns
Power Dissipation	P <sub>D</sub>	300	Watts
Junction Temperature Range	T <sub>J</sub>	-55 to +150	°C
Storage Temperature Range	T <sub>stg</sub>	-55 to +150	°C
Continuous Source Current (Body Diode)	I <sub>S</sub>	11	Amps
Pulse Source Current (Body Diode)	I <sub>SM</sub>	44	Amps
Thermal Resistance, Junction to Case	θ <sub>JC</sub>	0.25	°C/W



# MSAFX11P50A

## Electrical Parameters @ 25°C (unless otherwise specified)

DESCRIPTION	SYMBOL	CONDITIONS	MIN	TYP.	MAX	UNIT
Drain-to-Source Breakdown Voltage (Gate Shorted to Source)	$BV_{DSS}$	$V_{GS} = 0\text{ V}, I_D = 250\ \mu\text{A}$	500			V
Temperature Coefficient of the Drain-to-Source Breakdown Voltage	$\Delta BV_{DSS}/\Delta T_J$			0.054		%/°C
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\ \mu\text{A}$	2.0		4.5	V
Temperature Coefficient of the Threshold Voltage	$\Delta V_{GS(th)}/\Delta T_J$			0.12		%/°C
Gate-to-Source Leakage Current	$I_{GSS}$	$V_{GS} = \pm 20\text{V}_{DC}, V_{DS} = 0\text{ V}, T_J = 25^\circ\text{C}$ $T_J = 125^\circ\text{C}$			$\pm 100$ $\pm 200$	nA
Drain-to-Source Leakage Current (Zero Gate Voltage Drain Current)	$I_{DSS}$	$V_{DS} = 0.8 \cdot BV_{DSS}, T_J = 25^\circ\text{C}$ $V_{GS} = 0\text{ V}, T_J = 125^\circ\text{C}$			200 1000	$\mu\text{A}$
Static Drain-to-Source On-State Resistance (1)	$R_{DS(on)}$	$V_{GS} = 10\text{V}, I_D = 6\text{A}, T_J = 25^\circ\text{C}$ $I_D = 6\text{A}, T_J = 125^\circ\text{C}$		1.4	0.75	$\Omega$
Temperature Coefficient of the Drain-to-Source Resistance	$\Delta R_{DS(on)}/\Delta T_J$			0.6		%/°C
Forward Transconductance (1)	$g_{fs}$	$V_{DS} \geq 10\text{ V}; I_D = 11\text{ A}$	5	9		S
Input Capacitance Output Capacitance Reverse Transfer Capacitance	$C_{iss}$ $C_{oss}$ $C_{rss}$	$V_{GS} = 0\text{ V}, V_{DS} = 25\text{ V}, f = 1\text{ MHz}$		4700 430 135		pF
Turn-on Delay Time Rise Time Turn-off Delay Time Fall Time	$T_{d(on)}$ $t_r$ $t_{d(off)}$ $t_f$	$V_{GS} = 10\text{ V}, V_{DS} = 250\text{ V},$ $I_D = 6\text{ A}, R_G = 2.00\ \Omega$		33 27 35 35		ns
Total Gate Charge Gate-to-Source Charge Gate-to-Drain (Miller) Charge	$Q_{g(on)}$ $Q_{gs}$ $Q_{gd}$	$V_{GS} = 10\text{ V}, V_{DS} = 250\text{V}, I_D = 6\text{ A}$		160 50 95		nC
Body Diode Forward Voltage (1)	$V_{SD}$	$I_F = I_S, V_{GS} = 0\text{ V}$			3	V
Reverse Recovery Time (Body Diode)	$t_{rr}$	$I_F = 10\text{ A},$ 25 C $-di/dt = 100\text{ A}/\mu\text{s},$ 125 C			500 tbd	ns
Reverse Recovery Charge	$Q_{rr}$	$I_F = 10\text{ A},$ 25 C $di/dt = 100\text{ A}/\mu\text{s},$ 125 C			tbd tbd	$\mu\text{C}$

### Notes

- (1) Pulse test,  $t \leq 300\ \mu\text{s}$ , duty cycle  $\delta \leq 2\%$
- (2) Microsemi Corp. does not manufacture the mosfet die; contact company for details.

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